506679874 05/25/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KANG YOON LEE	05/24/2021
JONG WAN JO	05/24/2021
KYUNG DUK CHOI	05/24/2021
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17329158

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NAME OF SUBMITTER: SEUNG HO LEE

PATENT 506679874 REEL: 056335 FRAME: 0502

SIGNATURE:	/Seung Ho Lee/	
DATE SIGNED:	05/25/2021	
This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 2

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PATENT REEL: 056335 FRAME: 0503

Attorney Docke	it No.
Client Ref. No.	

DECLARATION AND ASSIGNMENT

Title of Invention: MAXIMUM POWER POINT TRACKING APPARATUS FOR ENERGY HARVESTING SYSTEM AND MAXIMUM POWER POINT TRACKING CONTROL METHOD
As the below named inventor, I hereby declare that:
This declaration is directed to:
[X] the attached application (Attorney Docket Number
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.
Whereas, each undersigned inventor (hereinafter referred to as "ASSIGNOR") has made certain inventions, improvements, and discoveries (herein referred to as the "INVENTION") disclosed in the above-identified patent application (herein referred to as the "APPLICATION");
Whereas, SKAIChips Co., Ltd. (hereinafter referred to as "ASSIGNEE"), organized and operating under the laws of Republic of Korea, whose post office address is 85511, 2066, Seobu-ro Jangan-gu, Suwon-si, Gyeonggi-do, 16419 Republic of Korea, and Research & Business Foundation SUNGKYUNKWAN UNIVERSITY (hereinafter referred to as "ASSIGNEE"), organized and operating under the laws of Republic of Korea, whose post office address is 2066, Seobu-ro, Jangan-gu, Suwon-si, Gyeonggi-do, 16419 Republic of Korea are desirous of securing the entire right, title, and interest in and to the INVENTION in all countries throughout the world, and in and to the APPLICATION for United States Letters Patent on this INVENTION and the Letters Patent to be issued upon this APPLICATION;
Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, ASSIGNOR hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the INVENTION, the APPLICATION, and any and all other patent applications and patents for the INVENTION which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filling of such applications and granting of such patents. In addition, ASSIGNOR hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the INVENTION, to ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by

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Attorney Docket NoClient Ref. No					
ASSIGNOR had this Assignment not been made, and ASSIGNOR agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the INVENTION, the APPLICATION, and all related patents and applications, in ASSIGNEE, its successors, legal representatives, whenever requested by ASSIGNEE, its successors, legal representatives, and assigns;					
AND, ASSIGNOR HEREBY covenants that ASSIGNOR has the full right to convey the interest assigned by this Assignment, and ASSIGNOR has not executed and will not execute any agreement in conflict with this Assignment;					
AND, ASSIGNOR HEREBY further covenants and agrees that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting said APPLICATION, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said INVENTION in all countries.					
Legal Name of Inventor: LEE, Kang Yoon	•				
Signature: For IC	Date:	05/24/2021			
Legal Name of Inventor: <u>JO, Jong Wan</u>		NAME DESTAYYY			
Signature:	Date:	15/24/3021			
Legal Name of Inventor: CHOL Kyung Duk		MM/ DO/ YYYY			
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		MINICODY YYYY			

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